

# ECL<sup>TM</sup>PS Plus™

## Product Preview ÷ 2 Divider

- 355ps Propagation Delay
- >4 GHz Toggle Frequency
- High Bandwidth Output Transistors
- PECL mode: 3.0V to 5.5V V<sub>CC</sub> with V<sub>EE</sub> = 0V
- ECL mode: 0V V<sub>CC</sub> with V<sub>EE</sub> = -3.0V to -5.5V
- Internal Input Resistors: Pulldown on D,  $\bar{D}$
- Q Output will default LOW with inputs open or at V<sub>EE</sub>
- ESD Protection: >4KV HBM, >200V MM
- V<sub>BB</sub> Output
- New Differential Input Common Mode Range
- Moisture Sensitivity Level 1, Indefinite Time Out of Drypack
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 78 devices

The MC10EP32 is an integrated  $\div 2$  divider. The differential clock inputs and the V<sub>BB</sub> allow a differential, single-ended or AC coupled interface to the device. If used, the V<sub>BB</sub> output should be bypassed to ground with a 0.01 $\mu$ F capacitor.

The reset pin is asynchronous and is asserted on the rising edge. Upon power-up, the internal flip-flops will attain a random state; the reset allows for the synchronization of multiple EP32's in a system.

## MC10EP32



**SO-8, D SUFFIX**  
8-LEAD PLASTIC SOIC PACKAGE  
CASE 751

### ORDERING INFORMATION

MC10EP32D SOIC

### PIN DESCRIPTION

PIN	FUNCTION
CLK, $\bar{CLK}$ Reset V <sub>BB</sub> Q, $\bar{Q}$	ECL Clock Inputs ECL Asynch Reset Ref Voltage Output ECL Data Outputs

### TRUTH TABLE

CLK	$\bar{CLK}$	RESET	Q	$\bar{Q}$
X	X	Z	L	H
Z	$\bar{Z}$	L	F	F

Z = LOW to HIGH Transition

$\bar{Z}$  = HIGH to LOW Transition

F = Divide by 2 Function

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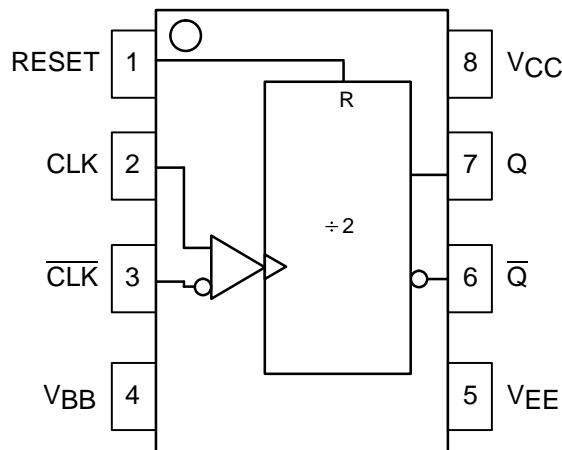


Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

**MAXIMUM RATINGS\***

Symbol	Parameter	Value	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 0V)	-6.0 to 0	VDC
V <sub>CC</sub>	Power Supply (V <sub>EE</sub> = 0V)	6.0 to 0	VDC
V <sub>I</sub>	Input Voltage (V <sub>CC</sub> = 0V, V <sub>I</sub> not more negative than V <sub>EE</sub> )	-6.0 to 0	VDC
V <sub>I</sub>	Input Voltage (V <sub>EE</sub> = 0V, V <sub>I</sub> not more positive than V <sub>CC</sub> )	6.0 to 0	VDC
I <sub>out</sub>	Output Current Continuous Surge	50 100	mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source Current†	± 0.5	mA
T <sub>A</sub>	Operating Temperature Range	-40 to +85	°C
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
θ <sub>JA</sub>	Thermal Resistance (Junction-to-Ambient) Still Air 500lpm	190 130	°C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	41 to 44 ± 5%	°C/W
T <sub>sol</sub>	Solder Temperature (<2 to 3 Seconds: 245°C desired)	265	°C

\* Maximum Ratings are those values beyond which damage to the device may occur.

† Use for inputs of same package only.

**DC CHARACTERISTICS, ECL/LVECL ( $V_{CC} = 0V$ ;  $V_{EE} = -5.5V$  to  $-3.0V$ ) (Note 4.)**

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>EE</sub>	Power Supply Current (Note 1.)	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2.)	-1135	-1060	-885	-1070	-945	-820	-1010	-885	-760	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2.)	-1935	-1810	-1685	-1870	-1745	-1620	-1810	-1685	-1560	mV
V <sub>IH</sub>	Input HIGH Voltage Single Ended	-1210		-885	-1145		-820	-1085		-760	mV
V <sub>IL</sub>	Input LOW Voltage Single Ended	-1935		-1610	-1870		-1545	-1810		-1485	mV
V <sub>BB</sub>	Output Voltage Reference	-1510	-1410	-1310	-1445	-1345	-1245	-1385	-1285	-1185	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 3.)	$V_{EE}+2.0$		0.0	$V_{EE}+2.0$		0.0	$V_{EE}+2.0$		0.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current	CLK	0.5			0.5			0.5		μA
		CLK	-150			-150			-150		

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpmin is maintained.

1.  $V_{CC} = 0V$ ,  $V_{EE} = V_{EEmin}$  to  $V_{EEmax}$ , all other pins floating.
2. All loading with 50 ohms to  $V_{CC}-2.0$  volts.
3.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .
4. Input and output parameters vary 1:1 with  $V_{CC}$ .

**DC CHARACTERISTICS, LVPECL ( $V_{CC} = 3.3V \pm 0.3V$ ,  $V_{EE} = 0V$ ) (Note 8.)**

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>EE</sub>	Power Supply Current (Note 5.)	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 6.)	2165	2240	2415	2230	2355	2480	2290	2415	2540	mV
V <sub>OL</sub>	Output LOW Voltage (Note 6.)	1365	1490	1615	1430	1555	1680	1490	1615	1740	mV
V <sub>IH</sub>	Input HIGH Voltage Single Ended	2090		2415	2155		2480	2215		2540	mV
V <sub>IL</sub>	Input LOW Voltage Single Ended	1365		1690	1430		1755	1490		1815	mV
V <sub>BB</sub>	Output Voltage Reference	1790	1890	1990	1855	1955	2055	1915	2015	2115	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 7.)	2.0		3.3	2.0		3.3	2.0		3.3	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current	CLK	0.5			0.5			0.5		μA
		CLK	-150			-150			-150		

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpmin is maintained.

5.  $V_{CC} = 3.3V$ ,  $V_{EE} = 0V$ , all other pins floating.
6. All loading with 50 ohms to  $V_{CC}-2.0$  volts.
7.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .
8. Input and output parameters vary 1:1 with  $V_{CC}$ .

DC CHARACTERISTICS, PECL ( $V_{CC} = 5.0V \pm 0.5V$ ,  $V_{EE} = 0V$ ) (Note 12.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current (Note 9.)	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	TBD	mA
$V_{OH}$	Output HIGH Voltage (Note 10.)	3865	3940	4115	3930	4055	4180	3990	4115	4240	mV
$V_{OL}$	Output LOW Voltage (Note 10.)	3065	3190	3315	3130	3255	3380	3190	3315	3440	mV
$V_{IH}$	Input HIGH Voltage Single Ended	3790		4115	3855		4180	3915		4240	mV
$V_{IL}$	Input LOW Voltage Single Ended	3065		3390	3130		3455	3190		3515	mV
$V_{BB}$	Output Voltage Reference	3490	3590	3690	3555	3655	3755	3615	3715	3815	mV
$V_{IHCMR}$	Input HIGH Voltage Common Mode Range (Note 11.)	2.0		5.0	2.0		5.0	2.0		5.0	V
$I_{IH}$	Input HIGH Current			150			150			150	$\mu A$
$I_{IL}$	Input LOW Current	CLK CLK	0.5 -150			0.5 -150			0.5 -150		$\mu A$

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpmin is maintained.

9.  $V_{CC} = 5.0V$ ,  $V_{EE} = 0V$ , all other pins floating.

10. All loading with 50 ohms to  $V_{CC}$ -2.0 volts.

11.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .

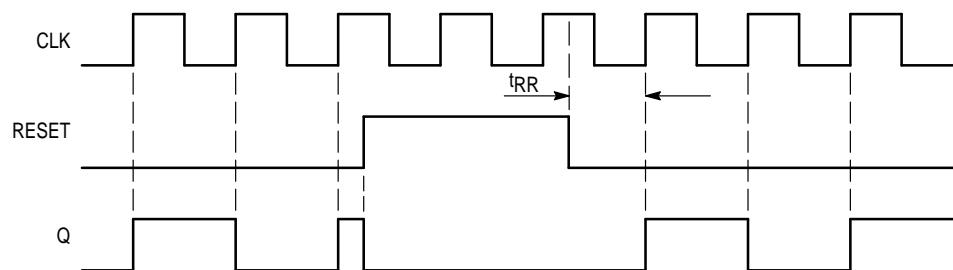
12. Input and output parameters vary 1:1 with  $V_{CC}$ .

AC CHARACTERISTICS ( $V_{CC} = 0V$ ;  $V_{EE} = -3.0V$  to  $-5.5V$ ) or ( $V_{CC} = 3.0V$  to  $5.5V$ ;  $V_{EE} = 0V$ )

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{max}$	Maximum Toggle Frequency (Note 13.)	TBD			TBD	4.0		TBD			GHz
$t_{PLH}, t_{PHL}$	Propagation Delay to Output Differential $CLK \rightarrow Q, \bar{Q}$ $RESET \rightarrow Q, \bar{Q}$	TBD TBD			TBD TBD	300 300		TBD TBD			ps
$t_{RR}$	Set/Reset Recovery		TBD			TBD			TBD		ps
$t_{SKEW}$	Duty Cycle Skew (Note 14.)		5.0			5.0	20		5.0	20	ps
$t_{PW}$	Minimum Pulse Width RESET		TBD			TBD			TBD		ps
$t_{JITTER}$	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
$V_{PP}$	Input Voltage Swing (Diff.)	150	800	1200	150	800	1200	150	800	1200	mV
$t_r$ $t_f$	Output Rise/Fall Times (20% – 80%) $Q, \bar{Q}$		TBD TBD			120 110			TBD TBD		ps

13.  $f_{max}$  guaranteed for functionality only.  $V_{OL}$  and  $V_{OH}$  levels are guaranteed at DC only.

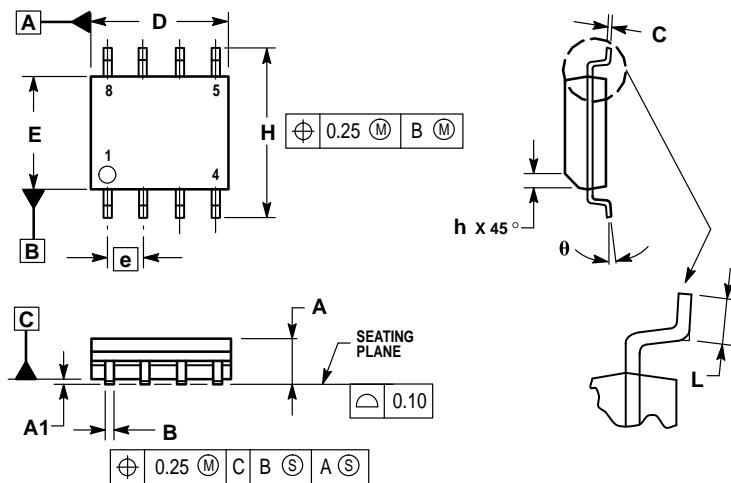
14. Skew is measured between outputs under identical transitions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.



**Figure 2. Timing Diagram**

## OUTLINE DIMENSIONS

**SO-8, D SUFFIX**  
**PLASTIC SOIC PACKAGE**  
**CASE 751-06**  
**ISSUE T**



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. DIMENSIONS ARE IN MILLIMETER.
3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
θ	0 °	7 °

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